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Low-voltage switchgear and controlgear – Controller-device interfaces (CDIs) –
Part 7: CompoNet

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Appareillage à basse tension – Interfaces appareil de commande-appareil (CDI) –
Partie 7: CompoNet

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This standard cancels and replaces IEC/PAS 62026-7 published in 2009. This first edition constitutes a general technical revision with clarifications only and with no significant change in the technology.

The text of this standard is based on the following documents:

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Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.